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Optimized electrode coverage of membrane actuators based on epitaxial PZT thin films

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Abstract
This research presents an optimization of piezoelectric membrane actuators by maximizing the actuator displacement. Membrane actuators based on epitaxial Pb(Zr, Ti)O₃ thin films grown on all-oxide electrodes and buffer layers using silicon technology were fabricated. Electrode coverage was found to be an important factor in the actuation displacement of the piezoelectric membranes. The optimum electrode coverage for maximum displacement was theoretically determined to be 39%, which is in good agreement with the experimental results. Dependences of membrane displacement and optimum electrode coverage on membrane diameter and PZT-film/Si-device-layer thickness ratio have also been investigated.

(Some figures may appear in colour only in the online journal)

1. Introduction

In recent times, piezoelectric micro-pumps have been developed in a variety of applications, ranging from controlling and delivering tiny amounts of fluids on a lab-on-a-chip system to use in laboratory experiments [1], especially in delivery and biomedical applications [2, 3]. Clearly, micro-pumps are one of the important microfluidic components where small size and accurate flow volume control are needed and, therefore, the design of micro-pumps plays an important role for practical applications of devices. To develop a suitable design of micro-pump for real-time applications it is very important to understand that these systems consist of many components, such as actuators, valves, chambers, nozzle diffuser mechanisms and appropriate pumping parameters [4–7]. In a ‘normal’ diaphragm pump, a piston moves a flexible diaphragm up and down for charging and discharging a liquid medium, displacing the medium pulse-wise. In a piezoelectric micro-pump, a piezoelectric element or piezoelectric actuator acts as the piston [8]. Therefore, the performance of micro-pumps depends strongly on the features of the piezoelectric membrane actuators [9–11].

Among piezoelectric materials, Pb(Zr, Ti)O₃ (PZT) is an attractive option for microelectromechanic systems (MEMS) technology due to its superior ferroelectric and piezoelectric properties [12]. In PZT materials, since bulk ceramic and thick film PZT are not suitable for miniature devices with low operating voltage, thin film technology has been widely used to prepare the submicron-thick PZT layer. Epitaxial growth of PZT thin films on a silicon substrate is considered to be a key technology for the fabrication of thinner and smaller electronic devices, because the leakage current is expected to be lower than that of polycrystalline films [13, 14]. Furthermore, epitaxial PZT films also exhibit much better ferroelectric and piezoelectric properties than polycrystalline PZT thin films [15].
The displacement of membrane actuators, based on PZT thin films and Si device layers, are controlled by many parameters: the growth technique, the thicknesses of the PZT thin-film and Si device layer, the membrane diameter and the top-electrode size. The membrane diameter can change the piezoelectric response, giving a high displacement and low resonance frequency for a large diameter. The thicknesses of the PZT film and Si device layer also have an influence on the piezoelectric properties, making it necessary to investigate these in order to improve the membrane performance.

The effect of the top-electrode size (or electrode coverage ‘EC’: the area ratio of the top-electrode to silicon membrane) on the piezoelectric responses has been described. For instance, Cho et al showed that an EC of 42% was predicted theoretically, while an EC of 60% was obtained from experiment, to give the maximum coupling coefficient [16, 17]. However, in a recent paper [18] Choi et al showed that the coupling coefficient was maximized when the electrode coverage was about 25%. This means that more studies are still necessary to understand the effect of electrode coverage on the piezoelectric responses of membrane actuators.

Concerning the dependence of the piezoelectric displacement of membranes on the electrode coverage there are a limited number of publications [19]. Therefore, in this paper, we have focused on the design, fabrication and characterization of membrane actuators based on epitaxial PZT thin films. The design was aimed at optimizing the piezoelectric response of the actuator membrane from the point of view of the top-electrode coverage. Pulsed laser deposition (PLD) of piezoelectric stack actuators based on thin films of Pb(Zr0.52Ti0.48)O3 (PZT) sandwiched between oxide SrRuO3 (SRO) electrodes deposited on ytrria-stabilized zirconia (YSZ) buffered Si substrates are presented in section 2.1. The ferroelectric properties are shown in section 2.2. The measurement technique used to define the piezoelectric responses is described in section 2.3. Finally, the relations between electrode coverage and the displacement and resonance frequency of the membrane actuator are discussed in section 3.

2. Experimental procedure

2.1. Design and fabrication of the piezoelectric micro-membranes

2.1.1. Thin film fabrication. Compared with other common film deposition techniques, such as sputter deposition [20, 21], evaporation [22, 23], metalorganic chemical vapor deposition (MOCVD) [24, 25] and sol–gel processing [26, 27], PLD has many important advantages for the epitaxial growth of oxide thin films. Most important is its ability to transfer material stoichiometrically from a multicomponent target to a growing film. This is very important for complex oxide-films such as PZT, because their physical properties depend strongly on the precise control of the chemical composition. The high supersaturation during each deposition pulse allows the growth of volatile thin film materials at high temperature. In the case of PZT thin film deposition, it results in a less significant loss of the more volatile elements, such as lead (Pb).

Figure 1 shows the fabrication process of the piezoelectric membrane. Devices were fabricated on p-type (100) silicon-on-insulator (SOI) substrates (size: 20 × 20 mm²) with a 5 ± 0.2 μm-thick Si device layer, a 2 ± 0.1 μm-thick buried-oxide (BOX) layer and a 380 ± 20 μm-thick Si handle layer, as shown in figure 1(a). The deposition of a piezoelectric stack SRO/PZT/SRO/YSZ began with the deposition of a 100 nm-thick YSZ buffer-layer on top of the SOI substrate (figure 1(b)). The YSZ buffer-layer prevents the formation of an excessive SiO₂ amorphous layer on the surface of the Si-substrate, creating a crystallization template for the epitaxial growth of the piezoelectric stack. Next, a 100 nm-thick SRO bottom electrode and a PZT layer (0.5–3.0 μm) are deposited. Deposition of the piezoelectric stack is completed with a 100 nm-thick SRO top-electrode layer. SRO is an ideal electrode in devices incorporating oriented ferroelectric films, due to its relatively high thermal conductivity and good compatibility in structure and chemistry with perovskite-type ferroelectric materials such as PZT, PbTiO₃ and BaTiO₃ [28]. Moreover, conductive SRO oxide electrodes are known to reduce the fatigue characteristics in both the ferroelectric and piezoelectric displacement properties, through compensation of the oxygen vacancies near the electrode/film interface by changing their oxygen non-stoichiometry [29, 30].

From x-ray diffraction (XRD), the (110)-orientation is measured for PZT thin films grown on SRO/YSZ/Si substrates, as previously observed [30]. The epitaxial orientation relationship with the Si-substrate was obtained for all YSZ, SRO and PZT layers, described by PZT(110) || SRO(110) || YSZ(001) || Si(001) [31].

2.1.2. PiezoMEMS devices fabrication. Figure 1(c) and (d) show the fabrication process of the piezoelectric membranes. First, the SRO top-electrode was etched by Ar-ion beam etching (figure 1(c)). Afterwards, the PZT film was sequential wet-etched and cleaned in diluted HF:HNO₃:H₂O and HCl:H₂O solutions at specific areas to access the bottom electrode (see figure 1(c)). A lateral underetch of about 1–2 μm for a 1 μm thick PZT layer was achieved. Then, the bottom SRO electrode and YSZ buffer-layer were also IBM etched. The etching rates are 10.0 nm min⁻¹ and 3.5 nm min⁻¹, respectively, for SRO and YSZ layers. Finally, the backside silicon hole was etched by deep reactive ion etching (DRIE) with the etching gases SF₆ (etching cycle) and C₂H₆ (passivation cycle) to release the membrane actuator. The BOX layer that acts as an etch stop in the DRIE process was then removed using buffered-hydrofluoric acid (HF 12.5%). A typical SEM image of the backside of a fabricated circular membrane actuator is shown in figure 2(a), in which the diameter corresponds to that of its design. The schematic cross-section and optical image (top-view) of a membrane actuator are shown in figures 1(e) and 2(d), respectively.
2.2. Measurement of ferroelectric properties

One of the key measurements for ferroelectric materials is, naturally, the measurement of the polarization hysteresis loop. The Sawyer–Tower circuit [32] is well-known as the (first) traditional hysteresis loop measurement setup (figure 3(a)), and this circuit has been modified to avoid noise by applying a virtual ground [33] (figure 3(b)). Nowadays, most testing of the ferroelectric capacitors is carried out using commercial apparatus available from one of two companies, Radiant Technologies and aixACCT. In this paper, the polarization hysteresis ($P–E$) loop was measured at $\pm 200$ kV cm$^{-1}$.
amplitude and 1 kHz frequency, using a ferroelectric tester system (aixACCT TF-2000 Analyzer). Together with remnant polarization, the dielectric constant and dielectric loss are also evaluated to quantify the quality of thin film deposition. The dielectric constant and dielectric loss are calculated from the capacitance measurement [34]. In this paper, a Süss MicroTech PM300 manual probe-station equipped with a Keithley 4200 Semiconductor characterization system was used for the capacitance measurement. The capacitance–electric field (C–E) measurement was performed at an ac signal of 1 kV cm\(^{-1}\) and 10 kHz frequency with the dc bias sweeping from −200 to +200 kV cm\(^{-1}\) and then back to −200 kV cm\(^{-1}\).

Figure 4 shows the remnant polarization (\(P_r\)), dielectric constant (\(\varepsilon\)) and dielectric loss (\(\tan\delta\)) of 1-µm-thick PZT film. The values of \(P_r\), \(\varepsilon\) and \(\tan\delta\) are 18.4 µC cm\(^{-2}\), 1360 and 0.03, respectively. They are in good agreement with the reported values [35], indicating good quality PZT films are formed.

2.3. Piezoelectric displacement and resonance responses

The Polytech MSA-400 micro-system analyzer was used for the analysis and visualization of the structural vibration in piezoelectric membranes. A fully integrated optical microscope with a scanning laser Doppler vibrometer (LDV) allows the measurement of the piezoelectric displacement as well as the resonant responses of piezoelectric actuators. For measuring the out-of-plane displacement of the membrane, the structure was excited by applying a sinusoidal ac-voltage of 6V\(_{p-p}\) (peak-to-peak) at 8 kHz frequency. This frequency is far away from the resonance frequencies of the actuators. The resonance-frequency measurement was performed at an excitation voltage of 1V\(_{ac}\) in the frequency range from 0 to 2 MHz. A scheme of the LDV is presented in figure 5.

3. Results and discussion

The optimal electrode coverage (EC) for the maximum piezoelectric actuator displacement can be predicted through an understanding of the mechanical stress in the membrane. Mechanical stress control in suspended membranes is important, as the intrinsic stress in the membrane directly determines the sensitivity of the actuator to any applied voltage. When an electrical field is applied across the top and bottom electrodes of the piezoelectric stack, the PZT film will expand or contract in the thickness direction, and oppositely contract or expand in the plane. Since the piezoelectric stack is fixed at the silicon–PZT interface this will induce a stress that will bend the membrane [37]. In extreme situations tensile stress can cause membranes to fracture, while compressive stresses result in collapsed membranes. Figure 6 shows the mechanical stress in the PZT/silicon membrane. When the tensile stress is induced in the central region in the lateral direction, the compressive stress is induced in the surroundings close to the membrane.
edge. The stresses in these two regions always have opposite signs to each other. A neutral-stress (or zero-stress) point exists between the two stressed regions [37]. In order to maximize the piezoelectric displacement of the membrane, the top-electrode in the piezoelectric sensors is located within the two neutral-stress points (called as the active area) to avoid opposite polarizations in the positive- and negative-stress regions canceling each other. The calculation and simulation results on the relation between piezoelectric displacement and electrode area show that there exists an optimal EC value that gives the highest displacement of the membrane [37]. The EC value can be written as:

$$ EC = \frac{\pi (d/2)^2}{\pi (D/2)^2} = \frac{1 + \nu}{3 + \nu} $$

where $d$ and $D$ are the diameters of the top-electrode and Si membrane, respectively, and $\nu$ is the Poisson’s ratio of the piezoelectric membrane.

Using the average Poisson’s ratio weighted by the thickness, for the two layers, such as the PZT film ($\nu = 0.30$, thickness: 5–3.0 µm) and the Si device layer ($\nu = 0.28$, thickness: 5 µm), then calculated EC values of about 39% are obtained. In this calculation, the contribution of the buffer-layer and electrode layers is assumed to be negligible due to the thickness of these layers being much thinner than that of the PZT film and Si device layer. The result shows that the thickness of the PZT film and/or Si device layer does not affect the calculated EC value (see more in equation (1)), because there is not much difference between the values of Poisson’s ratio for the PZT film and the Si device layer.

Figure 7(a) shows the center displacement and resonance frequency of the partially covered membrane in terms of the electrode coverage. When the EC value is reduced, the resonant spectrum will shift to a higher frequency range. The displacement corresponding to its resonance frequency first increases with increasing EC value and then decreases, reaching a maximum value at EC = 36%.

The next study is to find the optimized electrode coverage, where the diameters of the membrane are varied from 200 to 500 µm. Results of the piezoelectric displacement as a function of the EC value are shown in figures 8(a) and (b). The displacement is maximized at an EC value of 36% for membrane diameters of 300–500 µm. However, the maximum displacement was achieved at a lower EC value (25%) with the smaller membrane size (200 µm). This effect can be explained by a change in the clamped boundary condition at the edge of the membrane. The clamped edge is increased and then the active-area ratio in membrane ($d/D$, see figure 6) is reduced with a decreasing membrane diameter. The decrease of active-area ratio is directly related to the increase of the measured resonance frequency, in comparison with the calculated values (see figure 8(c)), with the decreasing membrane size.

In this paper, the resonance frequency of a circular membrane is calculated as [38]:

$$ f_r = \frac{\lambda_n^2 t}{2\pi r^2 \sqrt{\frac{E}{12\rho (1 - \nu^2)}}} $$

where $E$ and $\nu$ are the average Young’s modulus and average Poisson’s ratio of the membrane, respectively; $\rho$ is its average density, $t$ is its thickness and $r$ is radius of the membrane; $\lambda_n$ is the resonance eigenvalue, where $n$ denotes the resonance mode, i.e. first mode $\lambda_1 = 3.196$. The material parameters used for the silicon device and piezoelectric thin film are listed in table 1. In this calculation, the contribution of the buffer-layer and electrode layers is assumed to be negligible due to the thickness of these layers being much thinner than those of the PZT film and Si device layer.

Figure 9 shows the relative effect of the PZT film thickness on the membrane displacement. It is noted that the

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<td>Si device layer</td>
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<td>$E$ (GPa)</td>
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Figure 7. (a) Measured center-displacement and first-mode resonance frequency as a function of electrode coverage (EC) of 500-µm-diameter membrane actuators; (b) upward displacements at the first-mode resonance frequency ($f_1 = 339$ kHz) and (c) resonance-frequency spectrum, measured on a 500-µm-diameter PZT film membrane actuator with EC = 36%. The thicknesses of the PZT film and Si device layer are 1 and 5 µm, respectively.

Figure 8. (a) Displacement and (b) normalized displacement ($\delta/\delta_{max}$), measured on different diameters of membrane actuators and as a function of electrode coverage; (c) measured (solid line) and calculated (dotted line) values of the first-mode resonance frequency versus the inverse square of the radius of the membrane actuators with EC = 36%. The thicknesses of PZT film and Si device layer are 1 and 5 µm, respectively.
Figure 9. (a) Displacement and (b) normalized displacement ($\delta/\delta_{\text{max}}$), measured on membrane actuators as a function of the PZT-film/silicon-device thickness ratio ($h_p/h_s$) and as a function of electrode coverage. Inset figure presents a relation between first-mode resonance frequency and the $h_p/h_s$ ratio, measured on membrane actuators with EC = 36%. The thickness of the Si device layer is 5.0 $\mu$m.

The effect of film thickness on displacement can be explained based on: (i) the contribution of the domain structure in association with the change due to the residual stress and substrate clamping; and (ii) the existence of an interfacial layer between the film and electrode [46]. The increased effective piezoelectric coefficient $d_{33,f}$ with film thickness is caused by the reduction of the clamping effect induced by the silicon substrate [47], see figure 10 for instance, in which a $d_{33,f}$ saturation value was observed at a film thickness of 1 $\mu$m [46]. However, that optimized film thickness is also affected by the fabrication technique, e.g. the maximum of the $d_{33,f}$ value was attained for films thicker than 2 $\mu$m by using sol–gel method [48].

As seen in figure 9, an electrode coverage of 36% is also observed to give the maximum displacement. However, the EC value also varies with the $h_p/h_s$ ratio. The data shows that the optimal EC value is shifted to 49% with a $h_p/h_s$ ratio of 0.6. This can be explained by the decrease in the substrate clamping with increasing film thickness and leads to an increase in the active membrane area or EC value.

4. Conclusions

Piezoelectric micro-actuators based on epitaxial all-oxide piezoelectric film stacks and Si-membranes have been designed, fabricated, and characterized. Membrane diameter and top-electrode size were varied independently in order to understand their effects on the performance of the devices.

(i) The maximum center displacement is obtained at an optimal EC value of 36% when the membrane diameter is in the range 300–500 $\mu$m. With a smaller membrane size, the optimal EC is shifted towards a lower value.
(ii) The improvement in membrane displacement is mostly due to the increase in membrane diameter rather than to the optimization of the EC.

(iii) Experiments show that the $h_p/h_S$ ratio to maximize the membrane displacement is found to be 0.2–0.3 (or a thickness of PZT films in the range of 1.0–1.5 $\mu$m while the thickness of Si device layer is held constant at 5.0 $\mu$m).

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